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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chiu ming LUENG	12/22/2011
Mankit LEE	12/22/2011
Cheukwing LEUNG	12/23/2011
Ju ren DING	12/22/2011
Rong kwang NI	12/22/2011

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	13289399	

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ATTORNEY DOCKET NUMBER: 4593-360

NAME OF SUBMITTER: Joseph S. Presta

Total Attachments: 2 source=ASSIG#page1.tif source=ASSIG#page2.tif

> PATENT REEL: 027573 FRAME: 0184

OP \$40,00 13289399

ASSIGNMENT OF PATENT APPLICATION

(Inventors)

Chiu ming LUENG Mankit LEE Cheukwing LEUNG Ju ren DING Rong kwang Ni

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(Assignee) (Address)

SAE MAGNETICS (H.K.) LTD.

of SAE Technology Centre, 6 Science Park East Avenue, Hong Kong Science Park,

Shatin, N.T., Hong Kong, China

(hereinafter designated as the Assignee) the undersigned's entire right, title and interest for the United States, its territories, dependencies and possessions, and for the country of

(Other Countries) (Title)

in the invention, and all application(s) for patent and any Letters Patent which may be granted therefor, known as

MEASURING METHOD OF A MAGNETIC HEAD AND MEASURING APPARATUS

THEREOF (Case No. 4593-360)

for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed

or has already filed in

U.S. appln. Serial No. 13/289,399, filed on November 4, 2011.

The undersigned acknowledges an obligation of assignment of this invention to said

assignee at the time the invention was made.

The undersigned agree(s) to execute all papers and documents necessary in connection with the application or any interference which may be declared and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient and further to perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of NIXON & VANDERHYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhye P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s).

Date 22 Dec 2011	Signature of inventor	Ali Mij
Date	Signature of inventor	Chiu ming LUENG
Date 12 (23 20)	1	Mankit LEE
	Signature of inventor	Cheukwing LEUNG
Date 12/22/20[]	Signature of inventor	Ju ren DING
Date 12/20/261	/ Signature of inventor	Rong kwang Ni